



# CY7C185

## 8K x 8 Static RAM

### Features

- High speed
  - 15 ns
- Fast  $t_{DOE}$
- Low active power
  - 715 mW
- Low standby power
  - 220 mW
- CMOS for optimum speed/power
- Easy memory expansion with  $\overline{CE}_1$ ,  $CE_2$ , and  $\overline{OE}$  features
- TTL-compatible inputs and outputs
- Automatic power-down when deselected

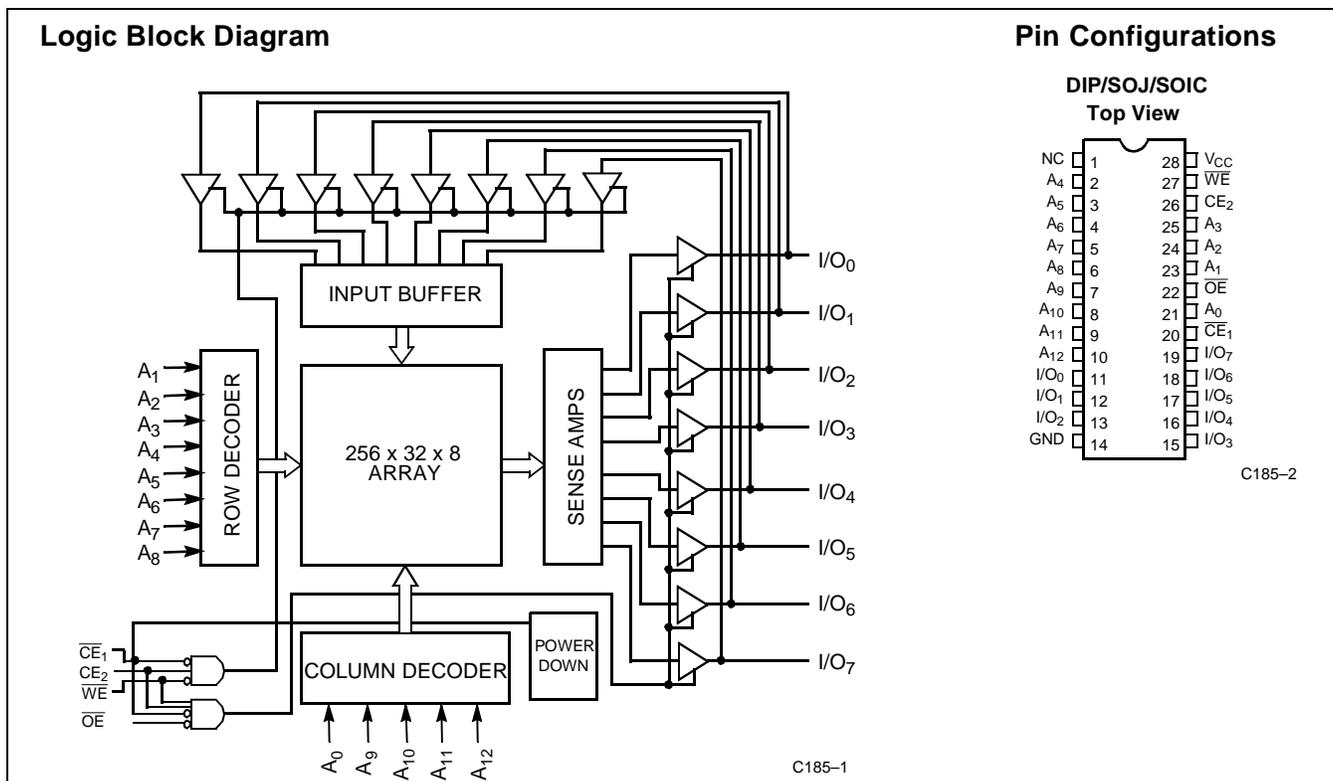
### Functional Description

The CY7C185 is a high-performance CMOS static RAM organized as 8192 words by 8 bits. Easy memory expansion is

provided by an active LOW chip enable ( $\overline{CE}_1$ ), an active HIGH chip enable ( $CE_2$ ), and active LOW output enable ( $\overline{OE}$ ) and three-state drivers. This device has an automatic power-down feature ( $\overline{CE}_1$  or  $CE_2$ ), reducing the power consumption by 70% when deselected. The CY7C185 is in a standard 300-mil-wide DIP, SOJ, or SOIC package.

An active LOW write enable signal ( $\overline{WE}$ ) controls the writing/reading operation of the memory. When  $\overline{CE}_1$  and  $\overline{WE}$  inputs are both LOW and  $CE_2$  is HIGH, data on the eight data input/output pins ( $I/O_0$  through  $I/O_7$ ) is written into the memory location addressed by the address present on the address pins ( $A_0$  through  $A_{12}$ ). Reading the device is accomplished by selecting the device and enabling the outputs,  $\overline{CE}_1$  and  $\overline{OE}$  active LOW,  $CE_2$  active HIGH, while  $\overline{WE}$  remains inactive or HIGH. Under these conditions, the contents of the location addressed by the information on address pins are present on the eight data input/output pins.

The input/output pins remain in a high-impedance state unless the chip is selected, outputs are enabled, and write enable ( $\overline{WE}$ ) is HIGH. A die coat is used to insure alpha immunity.



### Selection Guide<sup>[1]</sup>

	7C185-15	7C185-20	7C185-25	7C185-35
Maximum Access Time (ns)	15	20	25	35
Maximum Operating Current (mA)	130	110	100	100
Maximum Standby Current (mA)	40/15	20/15	20/15	20/15

**Note:**

1. For military specifications, see the CY7C185A datasheet.

### Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature ..... -65°C to +150°C  
 Ambient Temperature with  
 Power Applied..... -55°C to +125°C  
 Supply Voltage to Ground Potential ..... -0.5V to +7.0V  
 DC Voltage Applied to Outputs  
 in High Z State<sup>[2]</sup> ..... -0.5V to +7.0V  
 DC Input Voltage<sup>[2]</sup> ..... -0.5V to +7.0V

Output Current into Outputs (LOW) ..... 20 mA  
 Static Discharge Voltage ..... >2001V  
 (per MIL-STD-883, Method 3015)  
 Latch-Up Current..... >200 mA

### Operating Range

Range	Ambient Temperature	V <sub>CC</sub>
Commercial	0°C to +70°C	5V ± 10%
Industrial	-40°C to +85°C	5V ± 10%

### Electrical Characteristics Over the Operating Range

Parameter	Description	Test Conditions	7C185-15		7C185-20		Unit
			Min.	Max.	Min.	Max.	
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> = Min., I <sub>OH</sub> = -4.0 mA	2.4		2.4		V
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> = Min., I <sub>OL</sub> = 8.0 mA		0.4		0.4	V
V <sub>IH</sub>	Input HIGH Voltage		2.2	V <sub>CC</sub> + 0.3V	2.2	V <sub>CC</sub> + 0.3V	V
V <sub>IL</sub>	Input LOW Voltage <sup>[2]</sup>		-0.5	0.8	-0.5	0.8	V
I <sub>IX</sub>	Input Load Current	GND ≤ V <sub>I</sub> ≤ V <sub>CC</sub>	-5	+5	-5	+5	μA
I <sub>OZ</sub>	Output Leakage Current	GND ≤ V <sub>I</sub> ≤ V <sub>CC</sub> , Output Disabled	-5	+5	-5	+5	μA
I <sub>OS</sub>	Output Short Circuit Current <sup>[3]</sup>	V <sub>CC</sub> = Max., V <sub>OUT</sub> = GND		-300		-300	mA
I <sub>CC</sub>	V <sub>CC</sub> Operating Supply Current	V <sub>CC</sub> = Max., I <sub>OUT</sub> = 0 mA		130		110	mA
I <sub>SB1</sub>	Automatic Power-Down Current	Max. V <sub>CC</sub> , $\overline{CE}_1 \geq V_{IH}$ or CE <sub>2</sub> ≤ V <sub>IL</sub> Min. Duty Cycle = 100%	40		20		mA
I <sub>SB2</sub>	Automatic Power-Down Current	Max. V <sub>CC</sub> , $\overline{CE}_1 \geq V_{CC} - 0.3V$ , or CE <sub>2</sub> ≤ 0.3V V <sub>IN</sub> ≥ V <sub>CC</sub> - 0.3V or V <sub>IN</sub> ≤ 0.3V	15		15		mA

**Notes:**

2. Minimum voltage is equal to -3.0V for pulse durations less than 30 ns.
3. Not more than 1 output should be shorted at one time. Duration of the short circuit should not exceed 30 seconds.

**Electrical Characteristics** Over the Operating Range (continued)

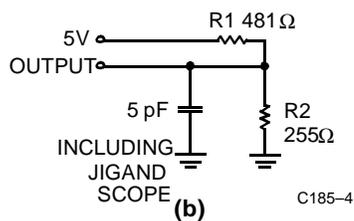
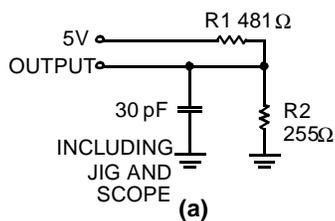
Parameter	Description	Test Conditions	7C185-25		7C185-35		Unit
			Min.	Max.	Min.	Max.	
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> = Min., I <sub>OH</sub> = -4.0 mA	2.4		2.4		V
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> = Min., I <sub>OL</sub> = 8.0 mA		0.4		0.4	V
V <sub>IH</sub>	Input HIGH Voltage		2.2	V <sub>CC</sub> + 0.3V	2.2	V <sub>CC</sub> + 0.3V	V
V <sub>IL</sub>	Input LOW Voltage <sup>[2]</sup>		-0.5	0.8	-0.5	0.8	V
I <sub>IX</sub>	Input Load Current	GND ≤ V <sub>I</sub> ≤ V <sub>CC</sub>	-5	+5	-5	+5	μA
I <sub>OZ</sub>	Output Leakage Current	GND ≤ V <sub>I</sub> ≤ V <sub>CC</sub> , Output Disabled	-5	+5	-5	+5	μA
I <sub>OS</sub>	Output Short Circuit Current <sup>[3]</sup>	V <sub>CC</sub> = Max., V <sub>OUT</sub> = GND		-300		-300	mA
I <sub>CC</sub>	V <sub>CC</sub> Operating Supply Current	V <sub>CC</sub> = Max., I <sub>OUT</sub> = 0 mA		100		100	mA
I <sub>SB1</sub>	Automatic Power-Down Current	Max. V <sub>CC</sub> , $\overline{CE}_1 \geq V_{IH}$ or CE <sub>2</sub> ≤ V <sub>IL</sub> Min. Duty Cycle=100%		20		20	mA
I <sub>SB2</sub>	Automatic Power-Down Current	Max. V <sub>CC</sub> , $\overline{CE}_1 \geq V_{CC} - 0.3V$ or CE <sub>2</sub> ≤ 0.3V V <sub>IN</sub> ≥ V <sub>CC</sub> - 0.3V or V <sub>IN</sub> ≤ 0.3V		15		15	mA

**Capacitance<sup>[4]</sup>**

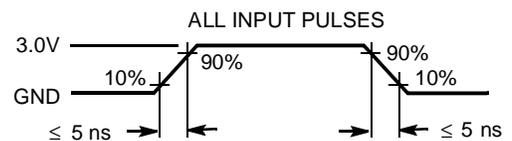
Parameter	Description	Test Conditions	Max.	Unit
C <sub>IN</sub>	Input Capacitance	T <sub>A</sub> = 25°C, f = 1 MHz, V <sub>CC</sub> = 5.0V	7	pF
C <sub>OUT</sub>	Output Capacitance		7	pF

**Note:**

4. Tested initially and after any design or process changes that may affect these parameters.

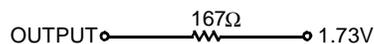
**AC Test Loads and Waveforms**


C185-4



C185-5

Equivalent to: THÉVENIN EQUIVALENT

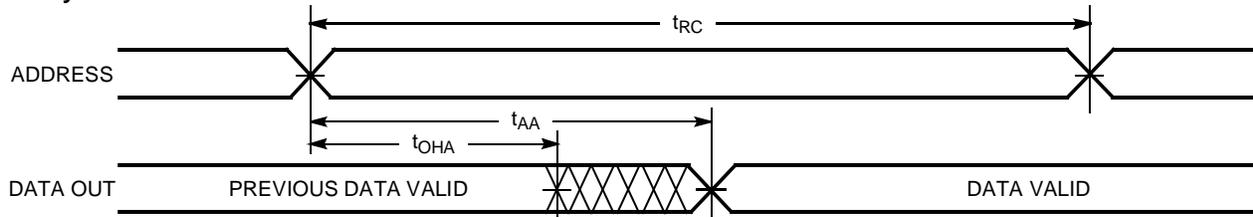


**Switching Characteristics** Over the Operating Range<sup>[5]</sup>

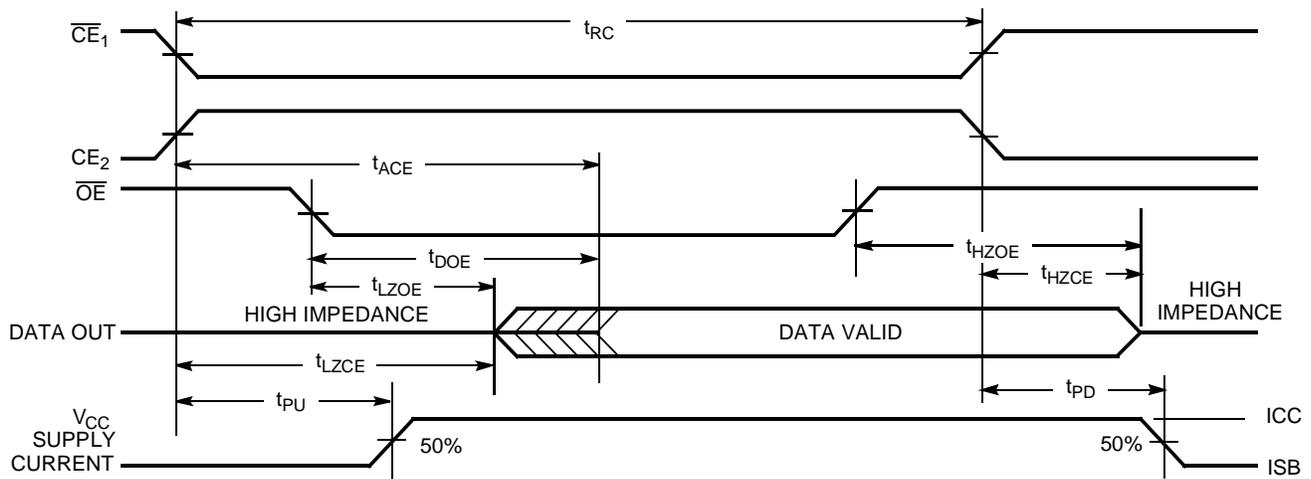
Parameter	Description	7C185-15		7C185-20		7C185-25		7C185-35		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>READ CYCLE</b>										
$t_{RC}$	Read Cycle Time	15		20		25		35		ns
$t_{AA}$	Address to Data Valid		15		20		25		35	ns
$t_{OHA}$	Data Hold from Address Change	3		5		5		5		ns
$t_{ACE1}$	$\overline{CE}_1$ LOW to Data Valid		15		20		25		35	ns
$t_{ACE2}$	$CE_2$ HIGH to Data Valid		15		20		25		35	ns
$t_{DOE}$	$\overline{OE}$ LOW to Data Valid		8		9		12		15	ns
$t_{LZOE}$	$\overline{OE}$ LOW to Low Z	3		3		3		3		ns
$t_{HZOE}$	$\overline{OE}$ HIGH to High Z <sup>[6]</sup>		7		8		10		10	ns
$t_{LZCE1}$	$\overline{CE}_1$ LOW to Low Z <sup>[7]</sup>	3		5		5		5		ns
$t_{LZCE2}$	$CE_2$ HIGH to Low Z	3		3		3		3		ns
$t_{HZCE}$	$\overline{CE}_1$ HIGH to High Z <sup>[6, 7]</sup> $CE_2$ LOW to High Z		7		8		10		10	ns
$t_{PU}$	$\overline{CE}_1$ LOW to Power-Up $CE_2$ to HIGH to Power-Up	0		0		0		0		ns
$t_{PD}$	$\overline{CE}_1$ HIGH to Power-Down $CE_2$ LOW to Power-Down		15		20		20		20	ns
<b>WRITE CYCLE<sup>[8]</sup></b>										
$t_{WC}$	Write Cycle Time	15		20		25		35		ns
$t_{SCE1}$	$\overline{CE}_1$ LOW to Write End	12		15		20		20		ns
$t_{SCE2}$	$CE_2$ HIGH to Write End	12		15		20		20		ns
$t_{AW}$	Address Set-Up to Write End	12		15		20		25		ns
$t_{HA}$	Address Hold from Write End	0		0		0		0		ns
$t_{SA}$	Address Set-Up to Write Start	0		0		0		0		ns
$t_{PWE}$	$\overline{WE}$ Pulse Width	12		15		15		20		ns
$t_{SD}$	Data Set-Up to Write End	8		10		10		12		ns
$t_{HD}$	Data Hold from Write End	0		0		0		0		ns
$t_{HZWE}$	$\overline{WE}$ LOW to High Z <sup>[6]</sup>		7		7		7		8	ns
$t_{LZWE}$	$\overline{WE}$ HIGH to Low Z	3		5		5		5		ns

**Notes:**

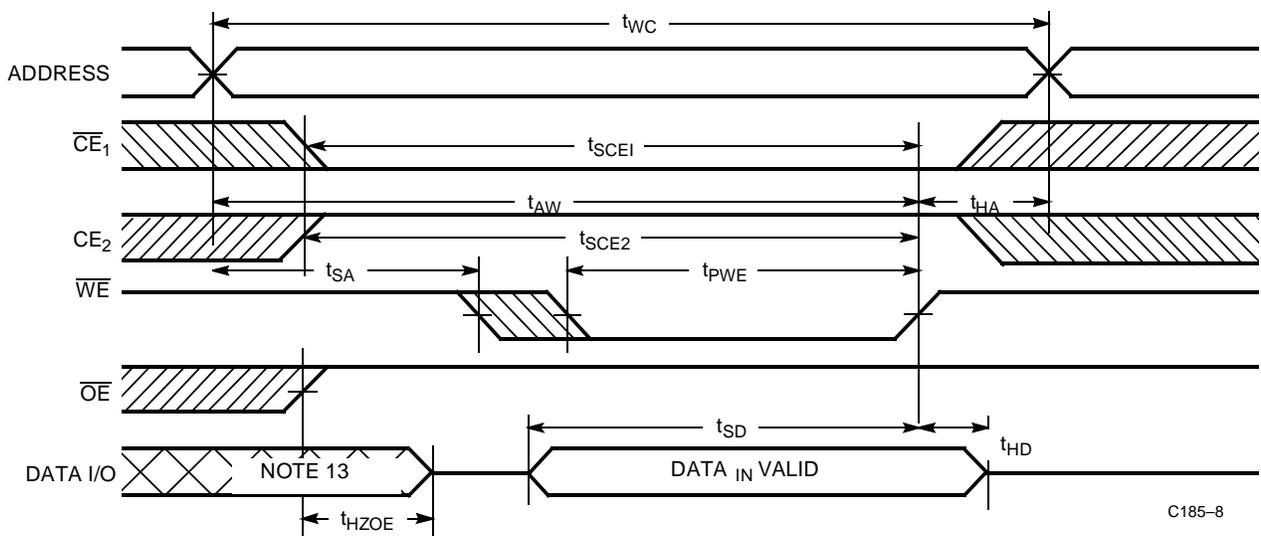
- Test conditions assume signal transition time of 5 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified  $I_{OL}/I_{OH}$  and 30-pF load capacitance.
- $t_{HZOE}$ ,  $t_{HZCE}$ , and  $t_{HZWE}$  are specified with  $C_L = 5$  pF as in part (b) of AC Test Loads. Transition is measured  $\pm 500$  mV from steady state voltage.
- At any given temperature and voltage condition,  $t_{HZCE}$  is less than  $t_{LZCE1}$  and  $t_{LZCE2}$  for any given device.
- The internal write time of the memory is defined by the overlap of  $\overline{CE}_1$  LOW,  $CE_2$  HIGH, and  $\overline{WE}$  LOW. All 3 signals must be active to initiate a write and either signal can terminate a write by going HIGH. The data input set-up and hold timing should be referenced to the rising edge of the signal that terminates the write.

**Switching Waveforms**
**Read Cycle No.1<sup>[9,10]</sup>**


C185-6

**Read Cycle No.2<sup>[11,12]</sup>**


C185-7

**Write Cycle No. 1 ( $\overline{WE}$  Controlled)<sup>[10,12]</sup>**


C185-8

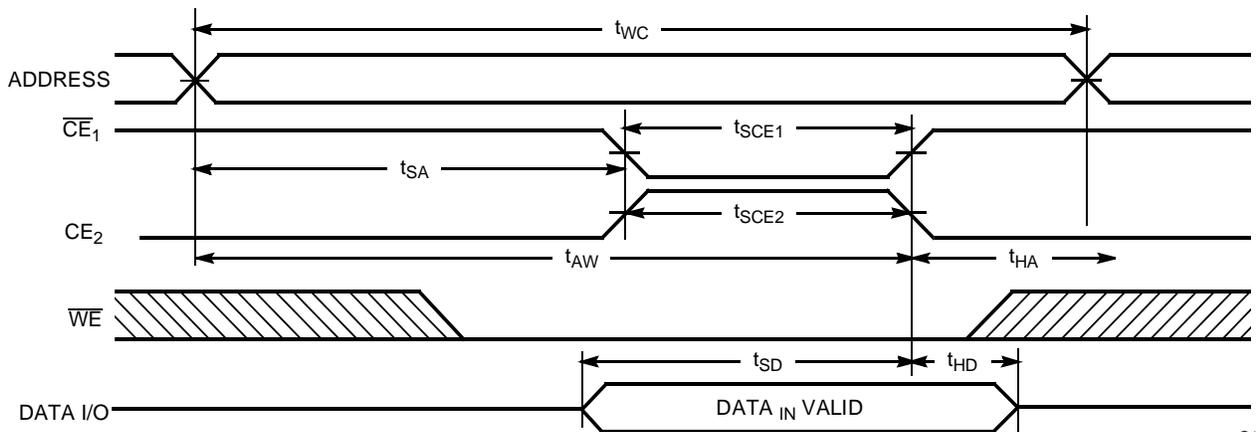
 9. Device is continuously selected.  $\overline{OE}$ ,  $\overline{CE}_1 = V_{IL}$ .  $CE_2 = V_{IH}$ .

 10.  $\overline{WE}$  is HIGH for read cycle.

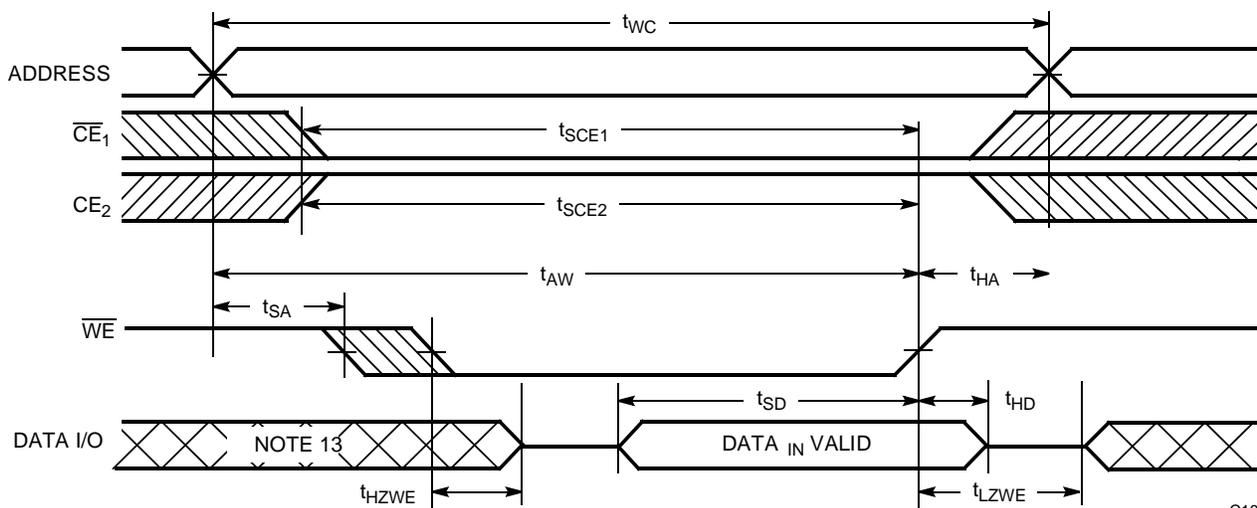
 11. Data I/O is High Z if  $\overline{OE} = V_{IH}$ ,  $\overline{CE}_1 = V_{IH}$ ,  $\overline{WE} = V_{IL}$ , or  $CE_2 = V_{IL}$ .

 12. The internal write time of the memory is defined by the overlap of  $\overline{CE}_1$  LOW,  $CE_2$  HIGH and  $\overline{WE}$  LOW.  $\overline{CE}_1$  and  $\overline{WE}$  must be LOW and  $CE_2$  must be HIGH to initiate write. A write can be terminated by  $\overline{CE}_1$  or  $\overline{WE}$  going HIGH or  $CE_2$  going LOW. The data input set-up and hold timing should be referenced to the rising edge of the signal that terminates the write.

13. During this period, the I/Os are in the output state and input signals should not be applied.

**Switching Waveforms (continued)**
**Write Cycle No. 2 ( $\overline{CE}$  Controlled)<sup>[12,13,14]</sup>**


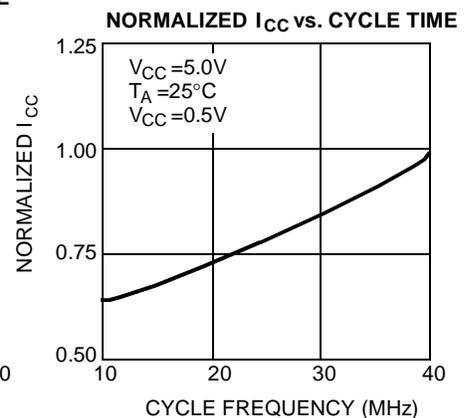
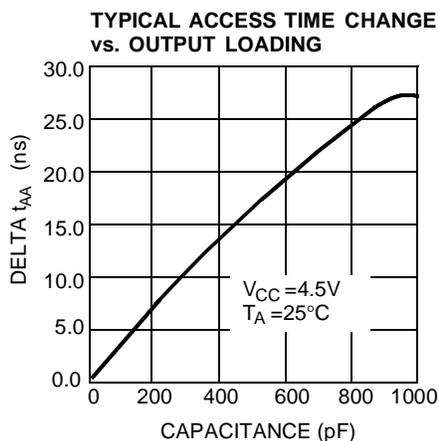
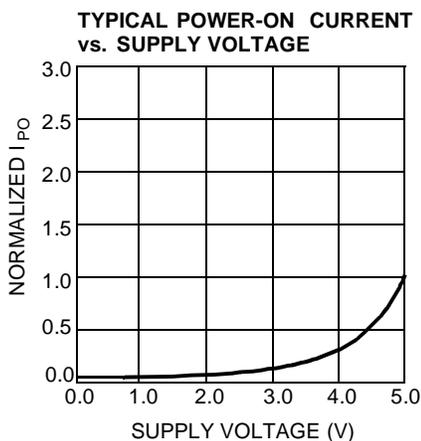
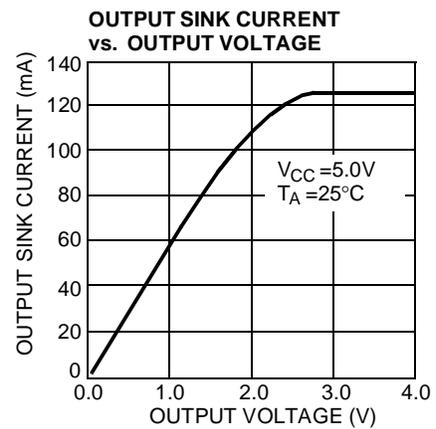
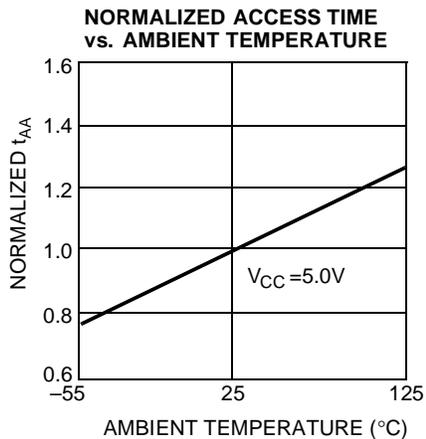
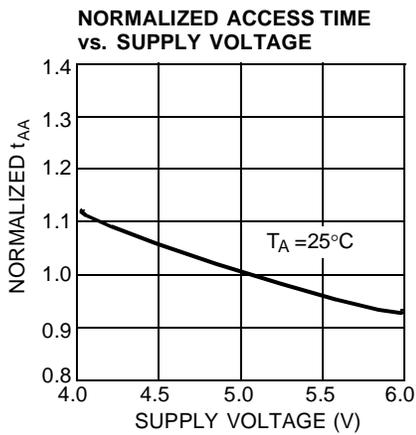
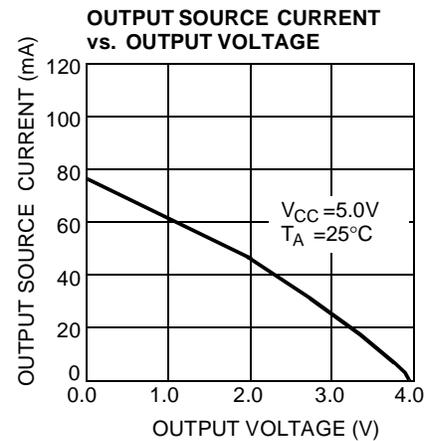
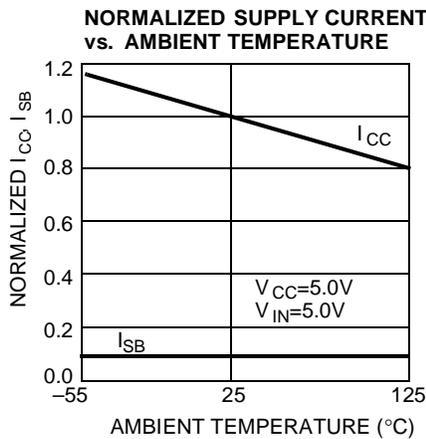
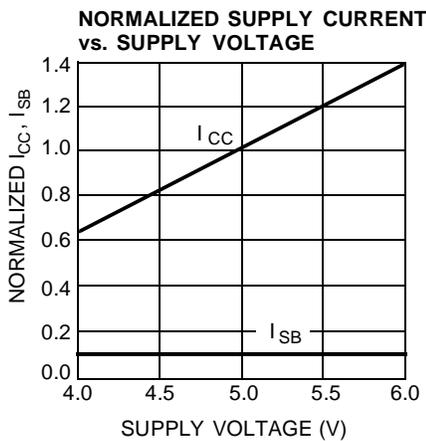
C185-9

**Write Cycle No. 3 ( $\overline{WE}$  Controlled,  $\overline{OE}$  LOW)<sup>[12,13,14,15]</sup>**


C185-10

**Notes:**

14. The minimum write cycle time for write cycle #3 ( $\overline{WE}$  controlled,  $\overline{OE}$  LOW) is the sum of  $t_{HZWE}$  and  $t_{SD}$ .
15. If  $\overline{CE}_1$  goes HIGH or  $\overline{CE}_2$  goes LOW simultaneously with  $\overline{WE}$  HIGH, the output remains in a high-impedance state.

**Typical DC and AC Characteristics**


**Truth Table**

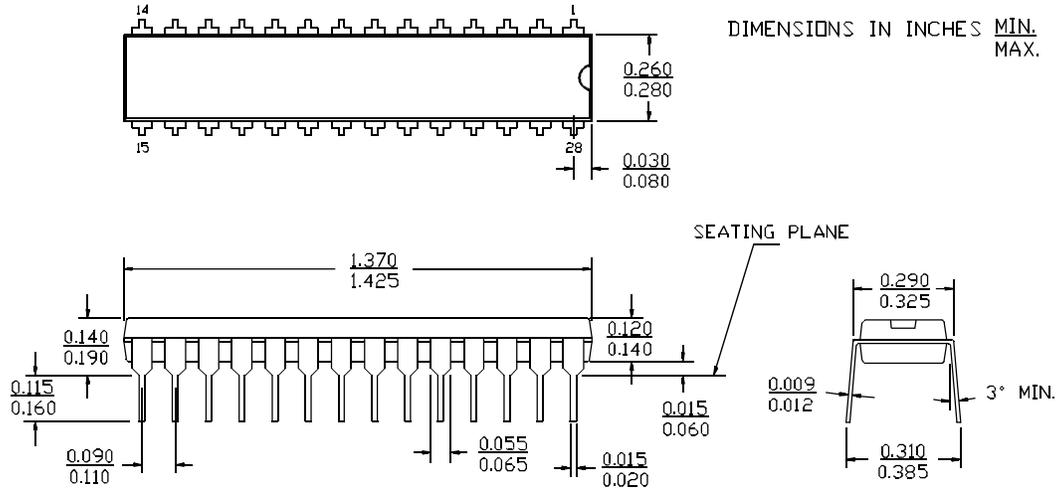
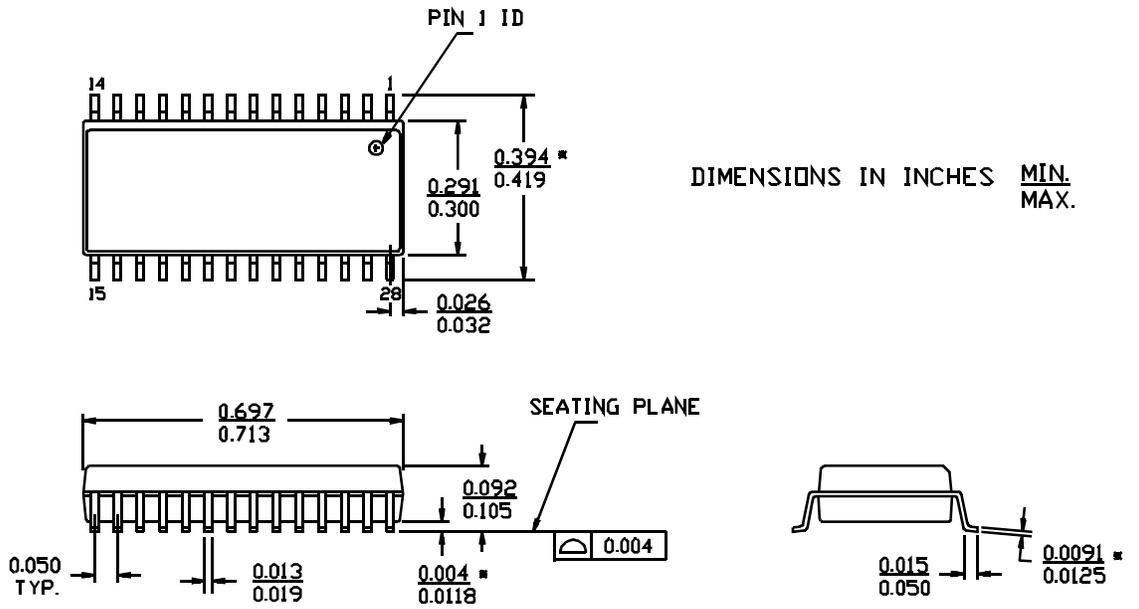
CE <sub>1</sub>	CE <sub>2</sub>	WE	OE	Input/Output	Mode
H	X	X	X	High Z	Deselect/Power-Down
X	L	X	X	High Z	Deselect/Power-Down
L	H	H	L	Data Out	Read
L	H	L	X	Data In	Write
L	H	H	H	High Z	Deselect

**Address Designators**

Address Name	Address Function	Pin Number
A4	X3	2
A5	X4	3
A6	X5	4
A7	X6	5
A8	X7	6
A9	Y1	7
A10	Y4	8
A11	Y3	9
A12	Y0	10
A0	Y2	21
A1	X0	23
A2	X1	24
A3	X2	25

**Ordering Information**

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
15	CY7C185-15PC	P21	28-Lead (300-Mil) Molded DIP	Commercial
	CY7C185-15SC	S21	28-Lead Molded SOIC	
	CY7C185-15VC	V21	28-Lead Molded SOJ	
	CY7C185-15VI	V21	28-Lead Molded SOJ	Industrial
20	CY7C185-20PC	P21	28-Lead (300-Mil) Molded DIP	Commercial
	CY7C185-20SC	S21	28-Lead Molded SOIC	
	CY7C185-20VC	V21	28-Lead Molded SOJ	
	CY7C185-20VI	V21	28-Lead Molded SOJ	Industrial
25	CY7C185-25PC	P21	28-Lead (300-Mil) Molded DIP	Commercial
	CY7C185-25SC	S21	28-Lead Molded SOIC	
	CY7C185-25VC	V21	28-Lead Molded SOJ	
	CY7C185-25VI	V21	28-Lead Molded SOJ	Industrial
35	CY7C185-35PC	P21	28-Lead (300-Mil) Molded DIP	Commercial
	CY7C185-35SC	S21	28-Lead Molded SOIC	
	CY7C185-35VC	V21	28-Lead Molded SOJ	
	CY7C185-35VI	V21	28-Lead Molded SOJ	Industrial

**Package Diagrams**
**28-Lead (300-Mil) Molded DIP P21**

**28-Lead (300-Mil) Molded SOIC S21**


**Package Diagrams** (continued)

**28-Lead (300-Mil) Molded SOJ V21**

 DIMENSIONS IN INCHES MIN.  
MAX.
